

限用物質含有情況標示

Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱 Equipment name	型號 (型式) Type designation (Type)	HLAW442, AW442120, : AW442160, AW442190, AW442190CN				
單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybromina ted biphenyls (PBB)	多溴二苯醚 Polybromina ted diphenyl ethers (PBDE)
電路板組 PCB	-	○	○	○	○	○
控制面板 Control panel	○	○	○	○	○	○
馬達 motor	-	○	○	○	○	○
外殼組件 Enclosure	○	○	○	○	○	○
螺絲與金屬組件 Screws & metal components	○	○	○	○	○	○
電源線組與線材 Power cord & wire	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1 : “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.						
備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2 : “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.						
備考3. “-” 係指該項限用物質為排除項目。 Note 3 : The “-” indicates that the restricted substance corresponds to the exemption.						